

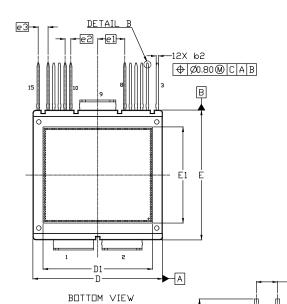
AHPM15 55x55 CASE MODHS ISSUE B

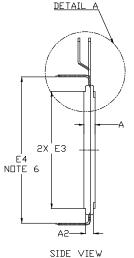
DATE 06 MAY 2022

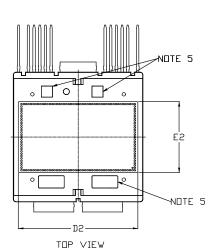
NOTES:

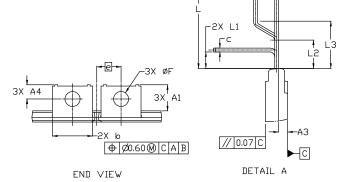
- 1. DIMENSIONING AND TOLERANCING PER. ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS D & E DO NOT INCLUDE MOLD PROTRUSIONS
- 4. DIMENSIONS 6,61,62 DO NOT INCLUDE DAMBAR REMAIN.
- 5. MARKING AREA.
 - E4 IS FROM INNER LEAD TIP TO INNER LEAD TIP DISTANCE.











DIM	MIN.	N□M.	MAX.
Α	4.65	4.70	4.75
A1	10.75	11.05	11.35
A2	3.20	3.40	3.60
A3	1.60	1.95	2.30
A4	5.70	6.00	6.30
b	16.90	17.00	17.10
b1	15.20	15.30	15.40
b2	0.90	1.00	1.10
b3	0.50 REF		
C	0.70	0.80	0.90
D	54.80	55.00	55.20
D1	45.80	46.80	47.80
D2	50.50	51.20	51.90

MILLIMETERS

MILLIMETERS			
. N	I□M.	MAX.	
30 5	5.00	55.20	
0 4	1.20	42.20	
30 3	0.50	31.20	
10 4	9.60	49.80	
0 6	2.00	62.40	
10.30 BSC			
11.45 BSC			
2.40 BSC			
4.20 BSC			
4.50 BSC			
5 6	5.50	6.55	
0 2	0.00	20.40	
) 3	3.50	3.90	
n Z	5.00	6,30	
0 0	5.00	0.00	
	0.00	10.30	
	. N 80 5 20 4 80 3 10 4 60 6 10.3 11.4 4.2 4.5 5 6 60 2	. NDM 80 55.00 . 41.20 . 30.30.50 . 49.60 . 62.00 . 10.30 BSC . 4.10 BSC . 4.20 BSC . 4.50 BSC . 6.50 . 0 20.00	

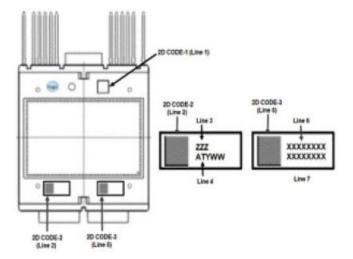
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DESCRIPTION:	AHPM15 55x55		PAGE 1 OF 2

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GENERIC MARKING DIAGRAM*



ZZZ = Assembly Lot CodeAT = Assembly & Test Location

Y = Year

WW = Work Week

XXXX = Specific Device Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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